



**PATENT**

**IN THE UNITED STATES PATENT AND TRADEMARK OFFICE**

**In re Application of:**

**Michael B. Ball**

**Serial No.: 09/427,123**

**Filed: October 22, 1999**

**For: MULTI-CHIP STACKED DEVICES**

**Examiner: R. Potter**

**Group Art Unit: 2822**

**Attorney Docket No.: 2818.1US  
(92-0399.1-RE)**

**CERTIFICATE OF MAILING**

I hereby certify that this correspondence along with any attachments referred to or identified as being attached or enclosed is being deposited with the United States Postal Service as First Class Mail (under 37 C.F.R. § 1.8(a)) on the date of deposit shown below with sufficient postage and in an envelope addressed to the Assistant Commissioner for Patents, Washington, D.C. 20231.

June 28, 2002  
Date of Deposit

Signature of registered practitioner or other person having reasonable basis to expect mailing to occur on date of deposit shown pursuant to 37 C.F.R. § 1.8(a)(1)(ii)

Deidra Pfeil  
Typed/printed name of person whose signature is contained above

**SUPPLEMENTAL REISSUE DECLARATION**

Assistant Commissioner for Patents  
Washington, D.C. 20231

Sir:

The undersigned declarant, Michael B. Ball, state and declare as follows:

I have reviewed the above-referenced continuing reissue application, the Preliminary Amendment filed concurrently therewith on October 22, 1999, and the Amendment to be filed concurrently herewith. All errors corrected by the above-referenced continuing reissue application up to and including the date I sign this Supplemental Reissue Declaration arose without any deceptive intention on my part.

Specifically, I acknowledge that the Amendment which is to be filed concurrently herewith cancels claims 3-12 of the above-referenced application, which have been withdrawn from consideration by the Office.

I acknowledge the duty to disclose to the Patent and Trademark Office all information known to be material to patentability of the subject matter claimed in this application, as "materiality" is defined in Title 37, Code of Federal Regulations, § 1.56.

I hereby declare that all statements made herein of my own knowledge are true and that all statements made on information and belief are believed to be true; and further that these statements were made with the knowledge that willful false statements and the like so made are punishable by fine or imprisonment, or both, under Section 1001 of Title 18 of the United States Code and that such willful false statements may jeopardize the validity of the application or any patent issued thereon.

Date: 6/23/02

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